



# THERMOSET TOPCON

Madison, Wisconsin • May 17-18, 2022

*Presented by SPE Thermoset Division*

**For Immediate Release: 18 AUGUST 2021**

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**SPE® THERMOSET DIV. ANNOUNCES CALL FOR PAPERS, SPONSORS & EXHIBITORS FOR THERMOSET TOPCON MAY 17 – 18, 2021 IN MADISON, WISCONSIN**

**“THERMOSETS – CROSSLINKING VALUABLE RESOURCES”**

The SPE Thermoset Div. is announcing its annual call for papers, exhibitors, and sponsors for their annual event to be held on May 17 – 18, 2022 at the Monona Terrace and Convention Center in Madison, Wisconsin. **“THERMOSETS – CROSSLINKING VALUABLE RESOURCES,”** is the theme for the 2022 event highlighting the value thermosets bring to a variety of products and the value of the companies and people in the industry. “Thermoset technologies continue to evolve and drive new and valuable composite applications in various industries,” said Richard Faulk, Product Manager, Materials Division Mar-Bal, Inc. and SPE Thermoset Div. Chair. “Our Thermoset TopCon 2022 event will crosslink thermoset technologies, companies, industry experts and students to further advance the industry,” continued Faulk. “We started the Thermoset Molding Conference in Madison, Wisconsin in 1954 in partnership with the University of Wisconsin, Madison and we are very excited to be back to celebrate the history, product advancements, and the future of thermoset technology,” added Faulk.

The SPE Thermoset TopCon 2022 will feature keynotes, technical presentations and exhibits highlighting advances in materials, processes, and equipment for thermoset technologies in electrical, automotive, off-highway, appliance, aerospace, building and construction, oil and gas, and other industries. The 2-day conference also includes networking breakfasts, lunches and a cocktail reception. A tour of the Polymer Engineering Center (PEC) at the University of Wisconsin-Madison is also included. Optional social events, including a golf outing at University Ridge Golf Course and a cruise of the Madison shoreline via private yacht with deluxe appetizers and beverages are offered on May 16, the day before the conference begins.

**Paper abstracts** are due January 17, 2022 and **final presentations** are due February 21, 2022. Limited time slots are available. Send abstracts to [teri@intuitgroup.com](mailto:teri@intuitgroup.com). **Speakers are invited to attend the event free of charge. OEMs are offered free registration as well.** A variety of **exhibit and non-exhibit sponsorship packages** offering opportunities for company exposure are available. Companies interested in showcasing their products and/or services, and individuals interested in registering to attend the event should go to <https://spethermosets.org/topcon/> for more information or contact Teri Chouinard at [teri@intuitgroup.com](mailto:teri@intuitgroup.com).

### **Conference Venue:**

Inspired by Wisconsin native Frank Lloyd Wright's design, at the peak of his creative powers in 1938, the Monona Terrace Community and Convention Center is one of the country's premier conference and convention facilities. On the shores of Lake Monona, it is an architecturally striking structure that connects the state capital, the cityscape, and the community. The conference exhibits, meals and cocktail reception will be in the Community Terrace with pristine views of Lake Monona offering a relaxing and enjoyable experience. The presentations will be in the Lecture Hall offering comfortable theatre style seating, staging and professional audio-visual support. Special rates are provided for conference attendees at the Hilton Madison Monona Terrace which is connected via skywalk to the conference venue. See <https://www.mononaterrace.com> and <https://www3.hilton.com/> for more info.

### **Sponsors:**

SPE Thermoset TopCon 2022 sponsors to date include: Mar-Bal, Inc.; Plenco (Plastics Engineering Company); Glenwood Tool & Mold, Inc.; Chromaflo Technologies; Huber Engineered Materials; IDI Composites; ICT Molding Solutions; American Colors, Cimbar, AOC, Molding Products, Penn Compression, Materia, Goettfert, LyondellBasell, Composites One, and Composites World.

The mission of SPE is to promote scientific and engineering knowledge relating to composites worldwide and to educate industry, academia, and the public about the technological advances. SPE's Thermoset Division is active in educating, promoting, recognizing, and communicating technical accomplishments in thermoset technology in multiple industries. Topic areas include applications, materials, processing, equipment, tooling, design, and development.

For more information see <https://spethermosets.org/topcon/> For more information on the *Society of Plastics Engineers*, see [www.4spe.org](http://www.4spe.org).

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